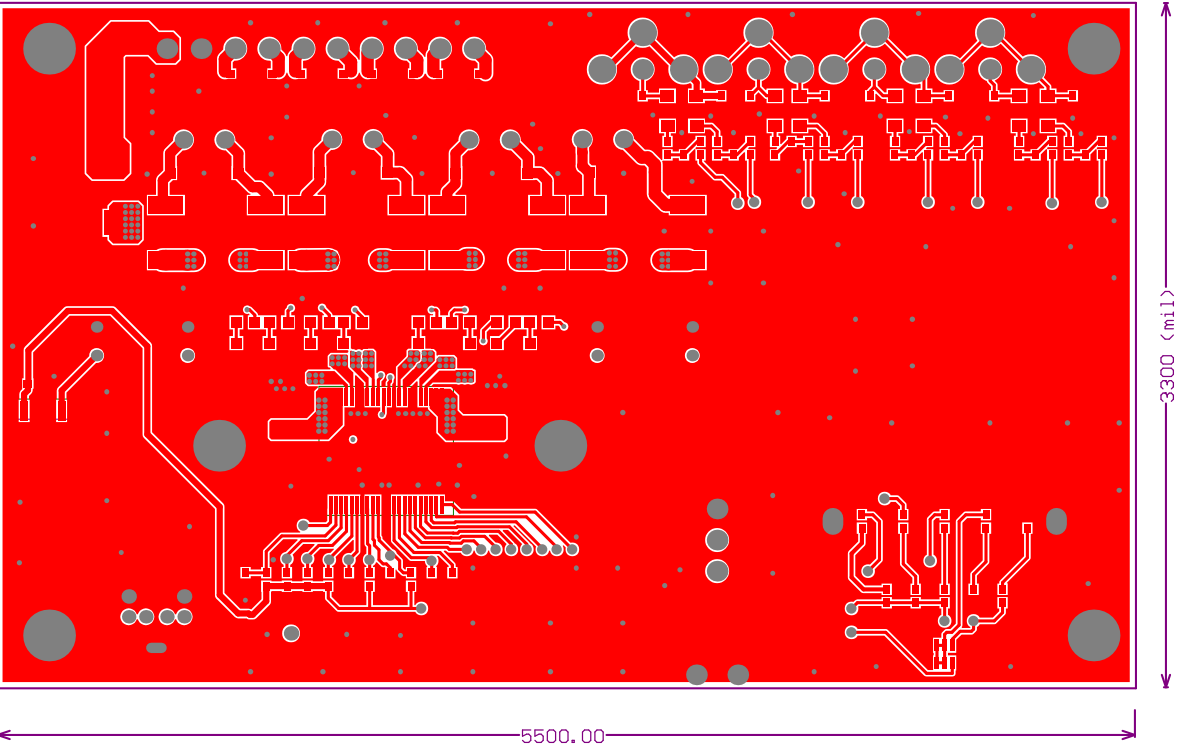


Title			TAS5424CQ1DKE EVM Schematic	
Size	Number		Revision	
A				
Date:	5/16/2013		Sheet	of
File:	C:\Users\...TAS5424CQ1DKEEVM_Sheet1.sch		1	1



### Fab Notes

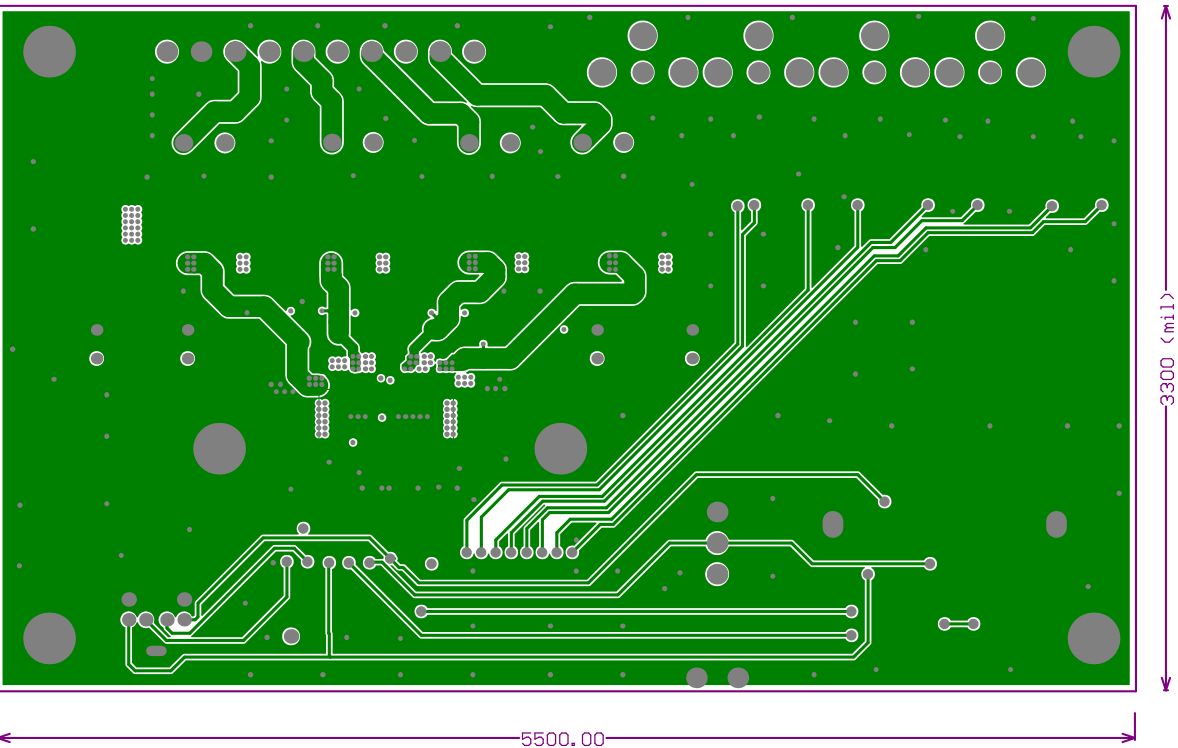
1. All plated through holes to be chemically cleaned
2. End item to meet or exceed IPC-A-600
3. Material: FR-370HR
4. Finished Thickness = 0.063 in. +/-0.005
5. All copper weight = 1oz
6. Position Accuracy = +/- 0.0015
7. Apply Blue Enthone soldermask to both sides of board  
separate artwork for bottom and top
8. Apply White LPI silkscreen to top side of board
9. Warpage = +/- 0.005 per linear inch max.
10. SMOBC
11. All holes are plated unless otherwise stated

Unless otherwise specified, Dimensions are in inches

Tolerances: Corners = 0.075 R Max  
Angles = +/- 5 degrees

Hole Diameters: <=0.080 +/-0.003  
>0.080 = +/- 0.004

Dimensional limits apply after plating and coating



Fab Notes

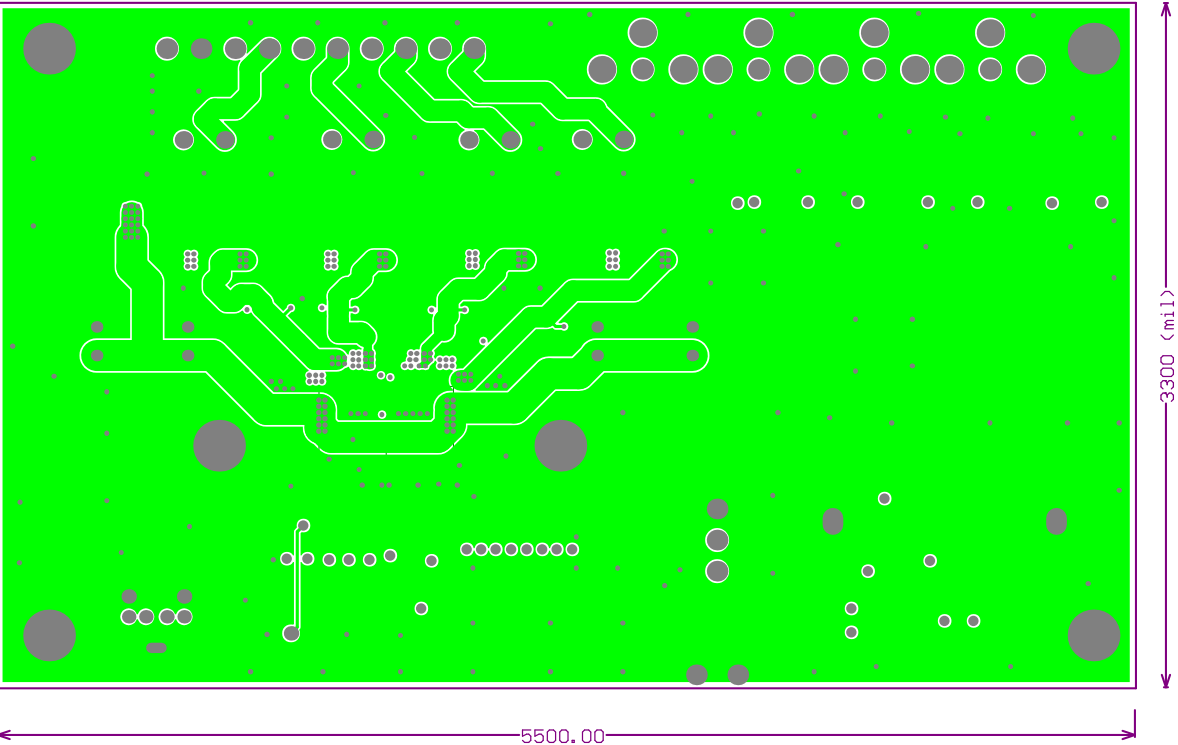
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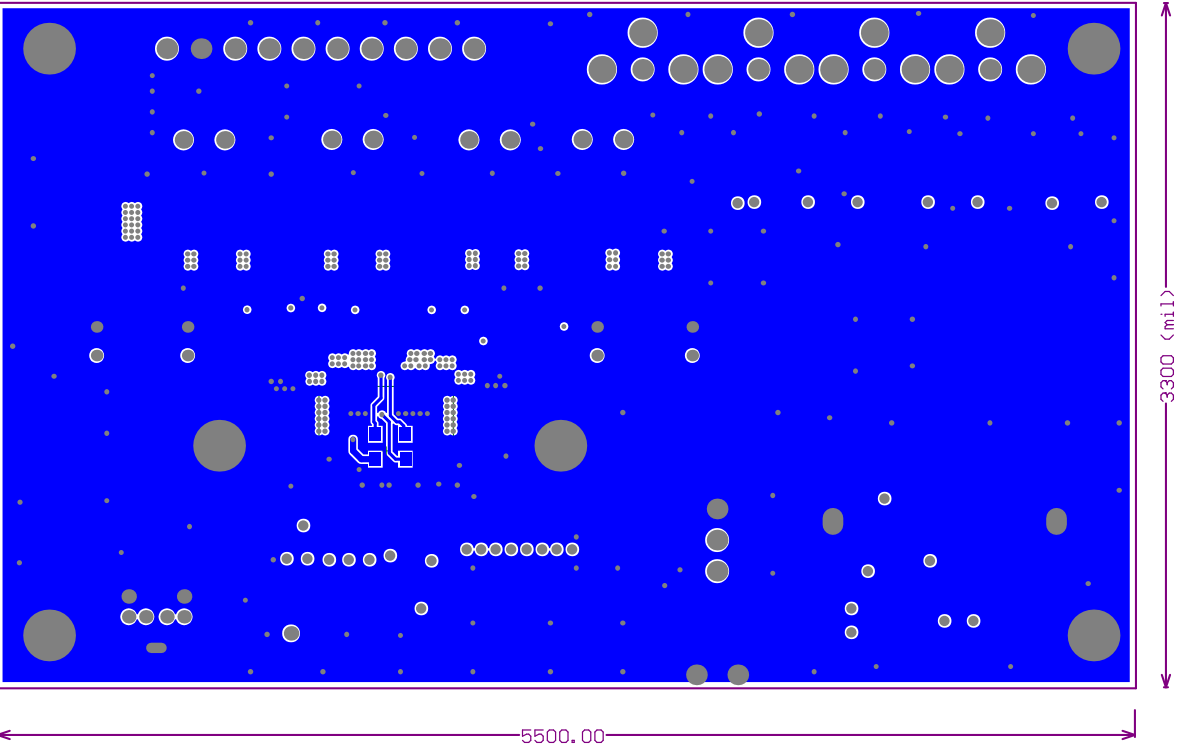
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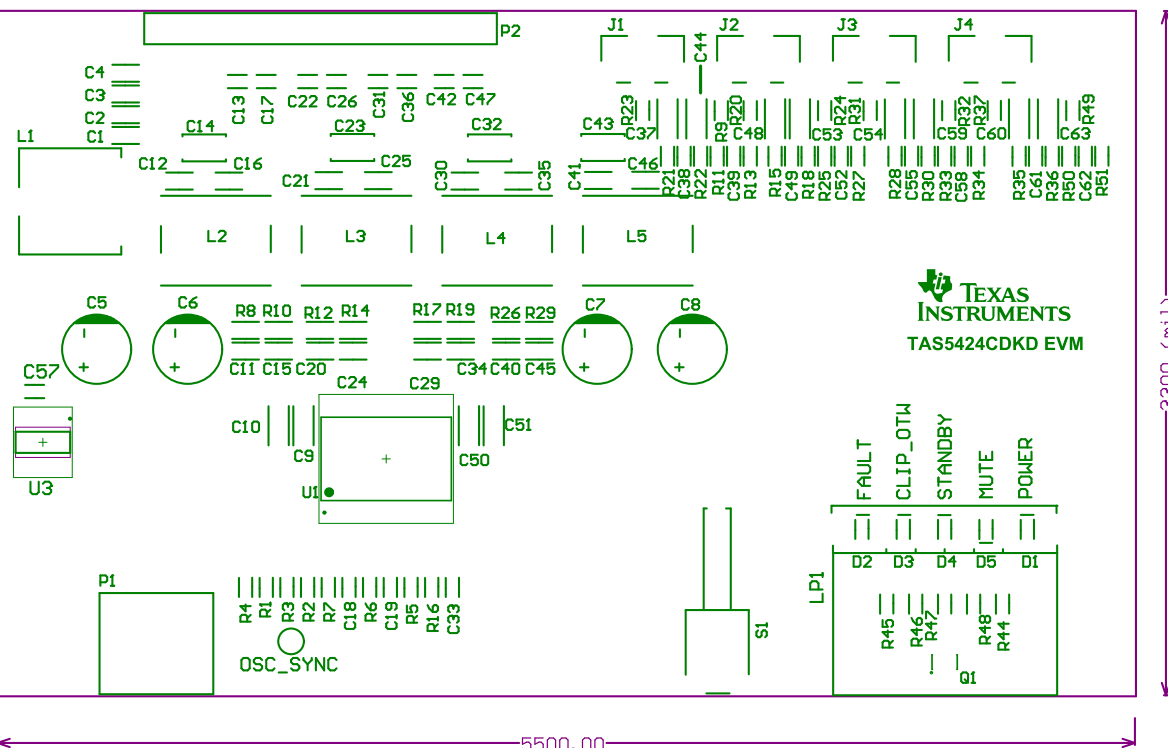
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